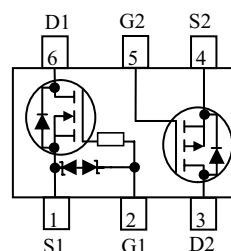
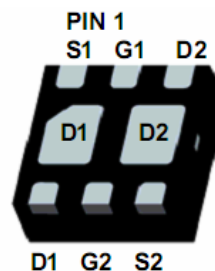


## WCM2001

N- and P-Channel Complementary, 20V, MOSFET

[Http://www.willsemi.com](http://www.willsemi.com)

$V_{(BR)DSS}$	$R_{DS(on)}$ Typ. ( m $\Omega$ )
N-Channel 20 V	180 @ 4.5V
	225 @ 2.5V
	280 @ 1.8V
P-Channel -20 V	85 @ -4.5V
	110 @ -2.5V
	150 @ -1.8V



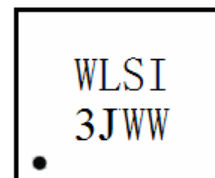
Pin configuration (Top view)

### Descriptions

The WCM2001 is the N- and P-Channel enhancement MOS Field Effect Transistor as a single package for DC-DC converter or Load switch applications, uses advanced trench technology and design to provide excellent  $R_{DS(ON)}$  with low gate charge. Standard Product WCM2001 is Pb-free.

### Features

- Trench Technology
- Supper high density cell design for extremely low  $R_{ds(on)}$
- Exceptional ON resistance and maximum DC current capability
- Small package design with DFN2x2-6L.



WLSI = Company  
3J = Device Code  
WW = Week Code

### Marking

### Order Information

Device	Package	Shipping
WCM2001-6/TR	DFN2x2-6L	3000/Tape&Reel

### Applications

- Driver: Relays, Solenoids, Lamps, Hammers
- Power supply converters circuit
- Load/Power Switching for potable device

**Absolute Maximum Ratings**

 (T<sub>A</sub>=25°C unless otherwise noted)

Symbol	Parameter	N-Channel	P-Channel	Unit
V <sub>DSS</sub>	Drain-to-Source Voltage	20	-20	V
V <sub>GSS</sub>	Gate-to-Source Voltage	±6	±8	V
I <sub>D</sub>	Drain Current – Continue <b>Note1</b>	0.65	-3.1	A
	Drain Current – Pulsed (t<300us, Duty<2%) <b>Note1</b>	1.4	-4.1	A
P <sub>D</sub>	Power Dissipation – <b>Note1</b>	1.5		W
	Power Dissipation – <b>Note2</b>	0.7		
T <sub>J</sub>	Operation junction temperature range	150		°C
T <sub>SG</sub>	Storage temperature range	-55~150		°C

**Thermal Resistance Ratings**

 (T<sub>A</sub>=25°C unless otherwise noted)

Symbol	Parameter	Single Operation		Dual Operation		Unit
		Typ.	Max.	Typ.	Max.	
R <sub>θJA</sub>	Thermal Resistance, Junction to Ambient – <b>Note1</b>	65	82	52	65	°C/W
R <sub>0JA</sub>	Thermal Resistance, Junction to Ambient – <b>Note2</b>	145	175	116	140	°C/W

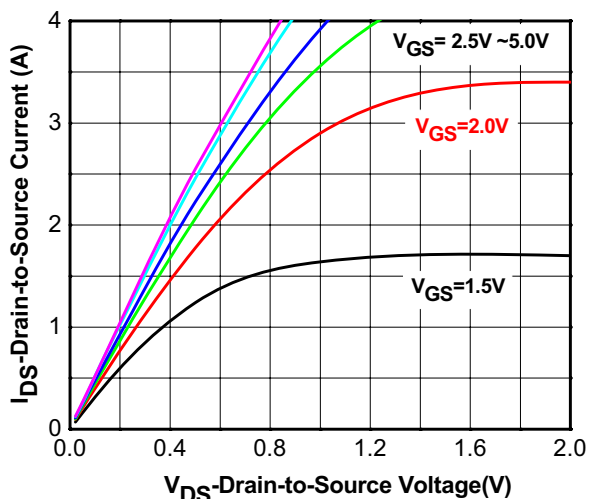
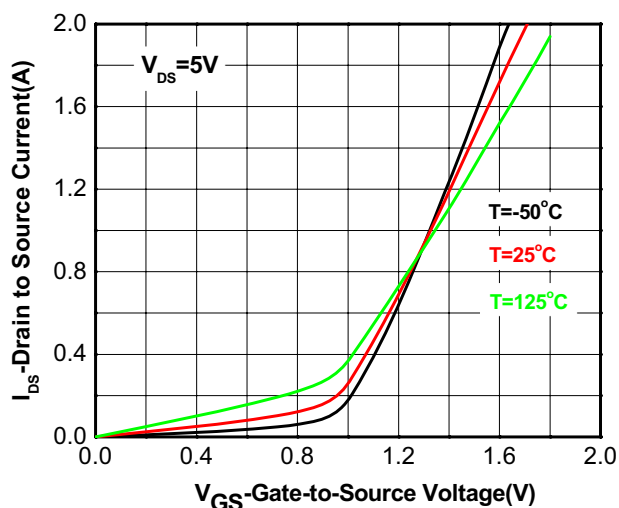
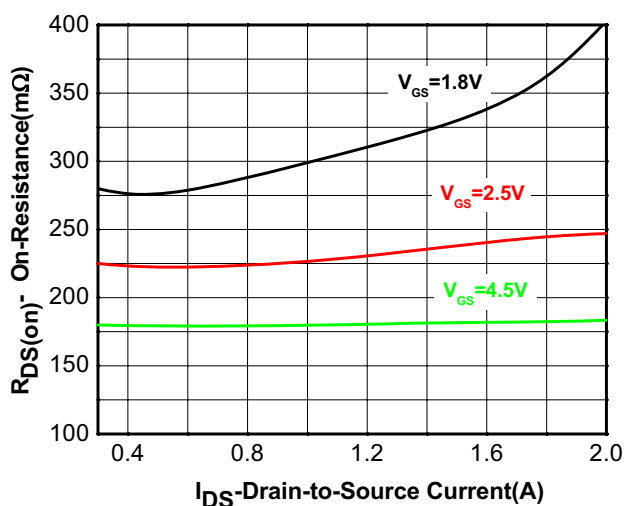
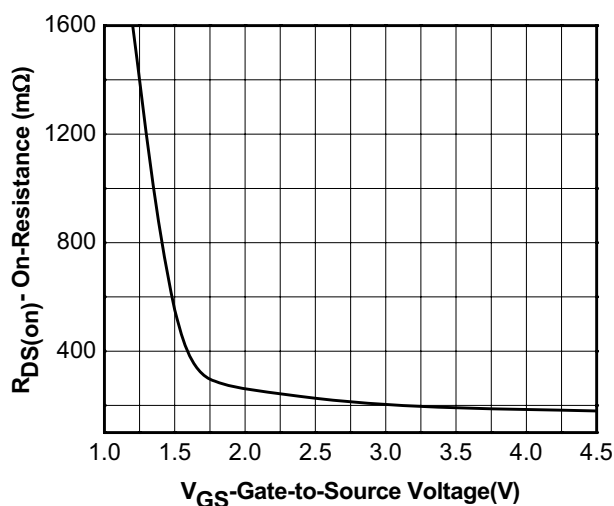
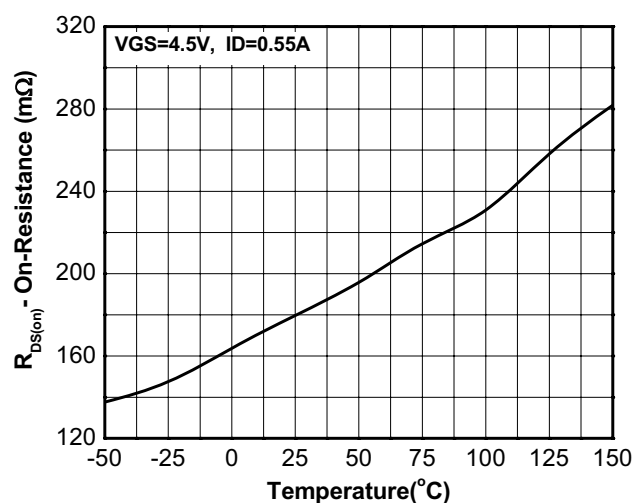
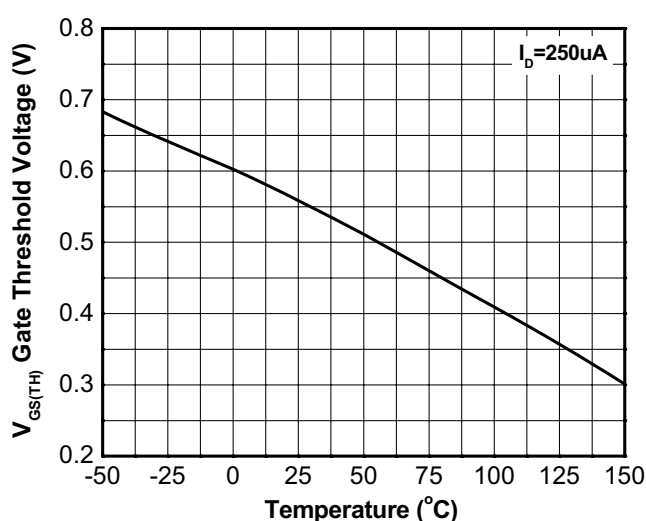
**Note1:** Surface mounted on a 2 oz copper, 1 in<sup>2</sup> pad, FR-4 board.

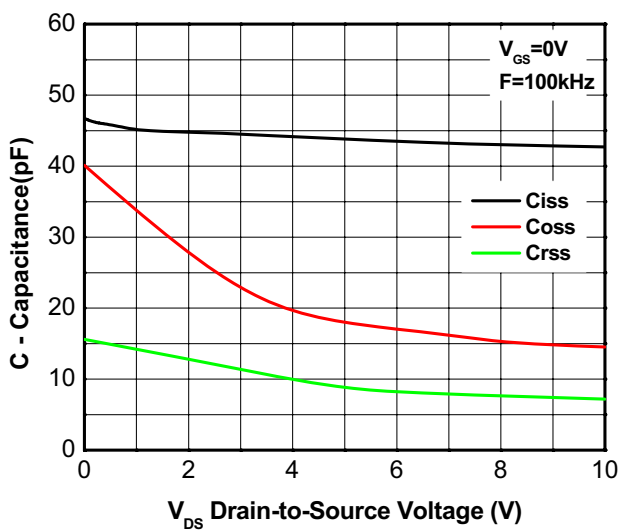
**Note2:** Surface mounted on a 2 oz copper, minimum pad, FR-4 board

**Electronics Characteristics ( $T_A=25^\circ\text{C}$  unless otherwise noted)**

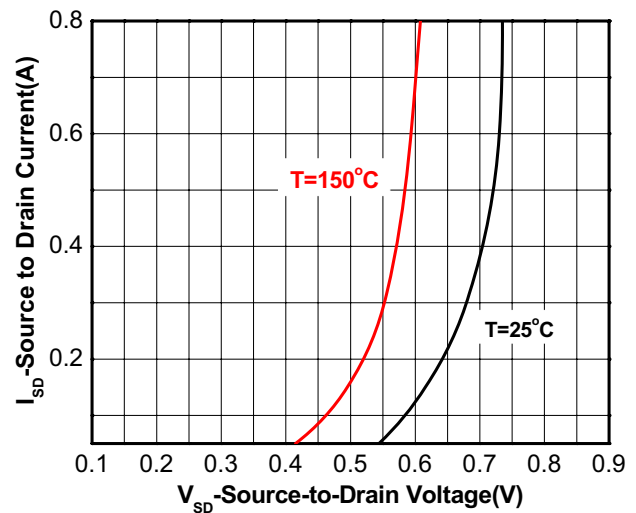
Symbol	Parameter	Test Condition	Min	Typ.	Max	Unit	
<b>Off Characteristics</b>							
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	N-Ch	20		V	
		$V_{GS}=0V, I_D=-250\mu A$	P-Ch	-20			
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS}=16V, V_{GS}=0V$	N-Ch		1	uA	
		$V_{DS}=-16V, V_{GS}=0V$	P-Ch		-1		
$I_{GSS}$	Gate –Source leakage current	$V_{DS}=0V, V_{GS}=\pm 5V$	N-Ch		$\pm 5$	uA	
		$V_{DS}=0V, V_{GS}=\pm 8V$	P-Ch		$\pm 0.1$		
<b>ON Characteristics</b>							
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	N-Ch	0.4	0.55	0.85	V
		$V_{DS}=V_{GS}, I_D=-250\mu A$	P-Ch	-0.4	-0.56	-1.00	
$R_{DS(on)}$	Drain-Source On-Resistance	$V_{GS}=4.5V, I_D=0.55A$	N-Ch		180	310	m $\Omega$
		$V_{GS}=-4.5V, I_D=-3.1A$	P-Ch		85	120	
		$V_{GS}=2.5V, I_D=0.45A$	N-Ch		225	360	
		$V_{GS}=-2.5V, I_D=-2.8A$	P-Ch		110	150	
		$V_{GS}=1.8V, I_D=0.35A$	N-Ch		280	460	
		$V_{GS}=-1.8V, I_D=-1.5A$	P-Ch		150	200	
$g_{FS}$	Forward Transconductance	$V_{DS}=5V, I_D=0.55A$	N-Ch		2.0	S	
		$V_{DS}=-5V, I_D=-0.45A$	P-Ch		12		
<b>Dynamic Characteristics</b>							
$C_{iss}$	Input Capacitance	NMOS: $V_{DS}=10V,$ $V_{GS}=0V, F=100kHz$ PMOS: $V_{DS}=-10V,$ $V_{GS}=0V, F=1MHz$	N-Ch		50	pF	
$C_{oss}$	Output Capacitance		P-Ch		470		
			N-Ch		13		
$C_{rss}$	Reverse Transfer Capacitance		P-Ch		55		
			N-Ch		8		
			P-Ch		50		
$Q_{G(TOT)}$	Total Gate Charge	NMOS: $V_{DS}=10V,$ $V_{GS}=4.5V, I_D=0.55A$ PMOS: $V_{DS}=-10V,$ $V_{GS}=-4.5V, I_D=-2.7A$	N-Ch		1.15	nC	
$Q_{G(TH)}$	Threshold gate charge		P-Ch		6		
			N-Ch		0.06		
$Q_{GS}$	Gate-Source Charge		P-Ch		0.34		
			N-Ch		0.15		
$Q_{GD}$	Gate-Drain Charge		P-Ch		0.75		
			N-Ch		0.23		
			P-Ch		1.2		

Symbol	Parameter	Test Condition	Min	Typ.	Max	Unit	
<b>Switching Characteristics</b>							
td(on)	Turn-On Delay Time	NMOS: $V_{DD}=10V$ , $R_L=18\Omega$ , $V_{GEN}=4.5V$ , $I_D=0.55A$ , $R_G=6\Omega$  PMOS: $V_{DD}=-10V$ , $R_L=3.7\Omega$ , $V_{GEN}=-4.5V$ , $I_D=-2.7A$ , $R_G=6\Omega$	N-Ch	22		ns	
			P-Ch	9			
tr	Turn-On Rise Time		N-Ch	80			
			P-Ch	7			
td(off)	Turn-Off Delay Time		N-Ch	700			
			P-Ch	40			
tf	Turn-Off Fall Time	N-Ch	380				
		P-Ch	7				
<b>Drain-to-Source Diode Characteristics</b>							
V <sub>SD</sub>	Forward Diode Voltage	$V_{GS}=0V$ , $I_S=0.15A$	N-Ch	0.5	0.70	1.5	V
		$V_{GS}=0V$ , $I_S=-0.9A$	P-Ch	-0.5	-0.70	-1.5	

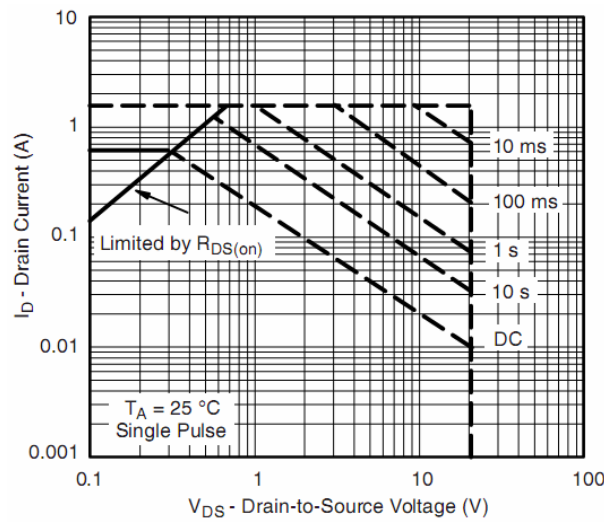
**Typical Performance Graph (N-Channel)**

**Output characteristics**

**Transfer characteristics**

**On-Resistance vs. Drain current**

**On-Resistance vs. Gate-to-Source voltage**

**On Resistance vs. Junction Temperature**

**Threshold voltage vs. Temperature**



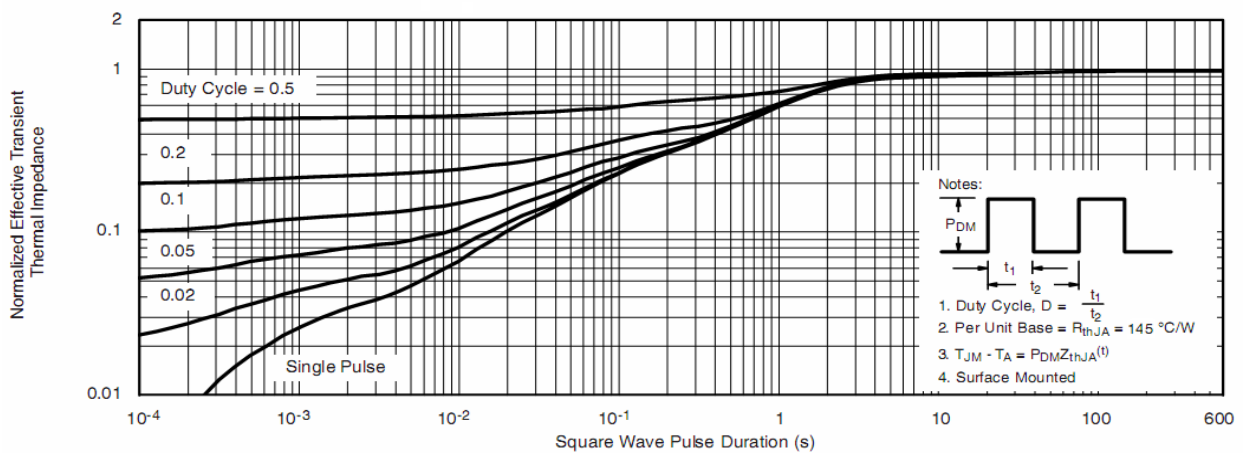
Capacitance



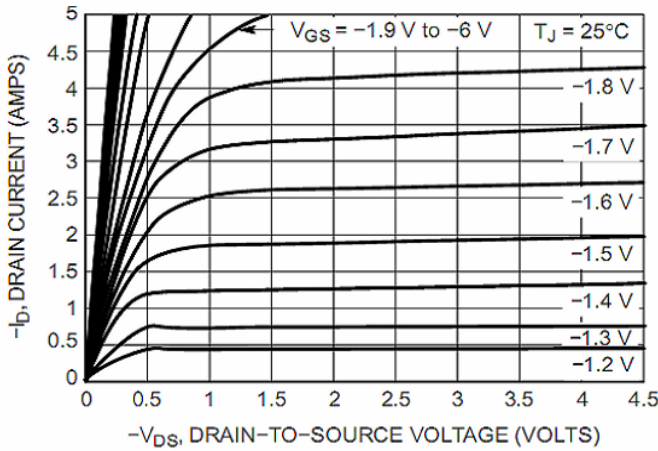
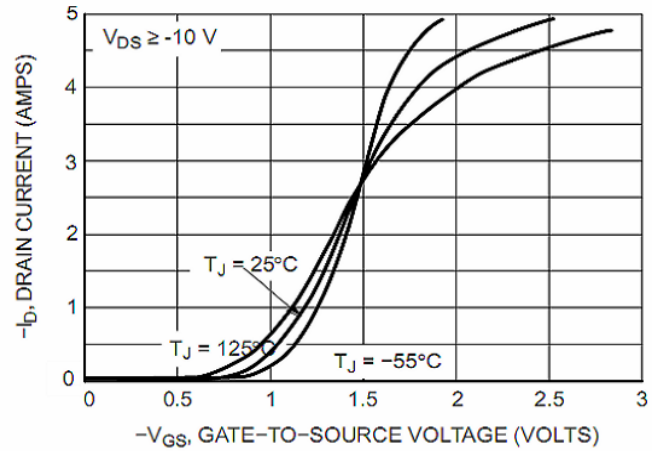
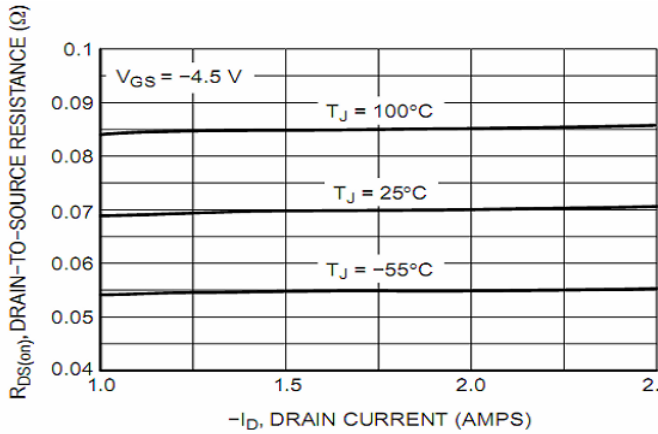
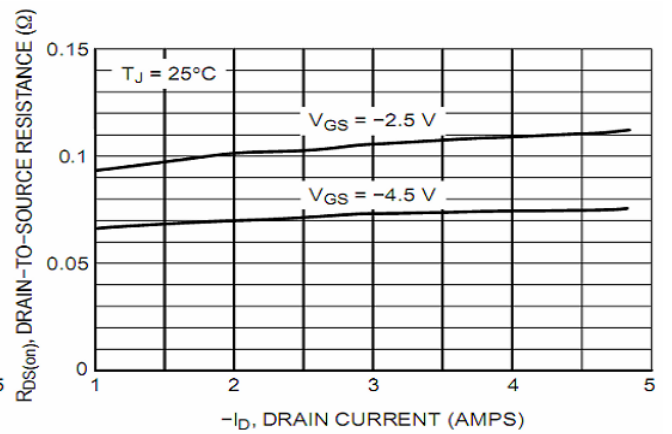
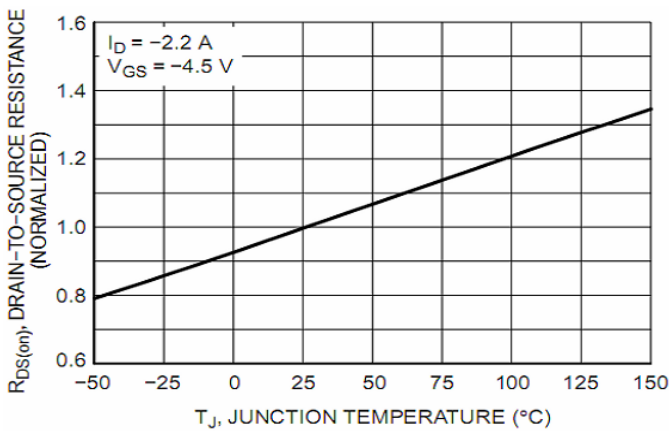
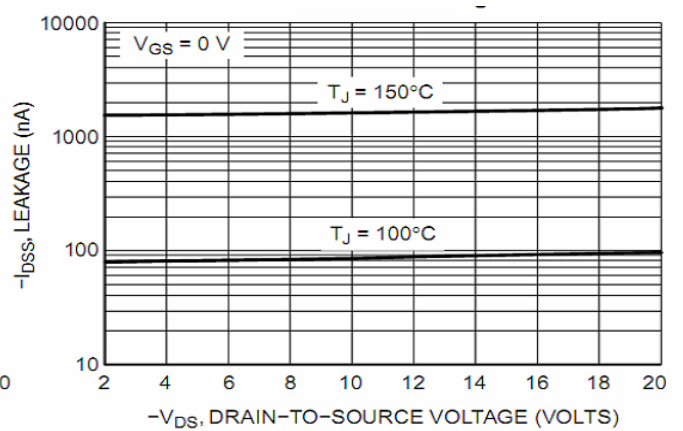
Body diode forward voltage

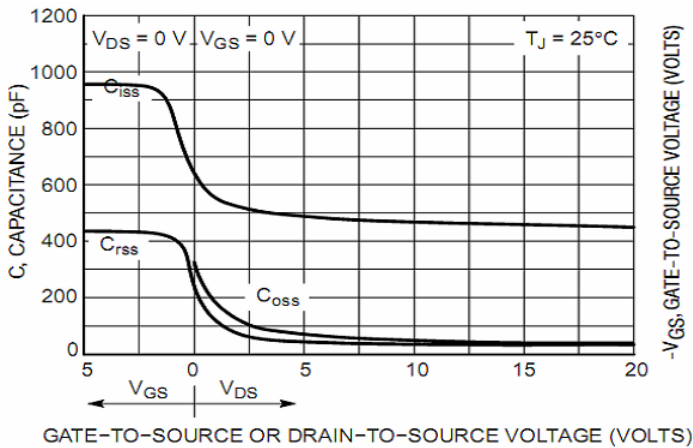


Safe operating power

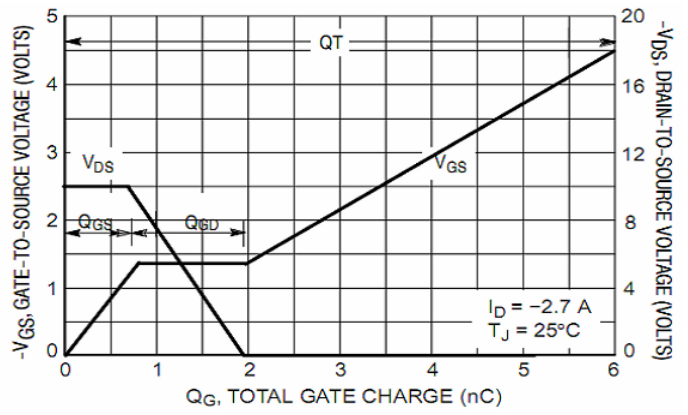


Normalized Thermal Transient Impedance, Junction-to-Ambient

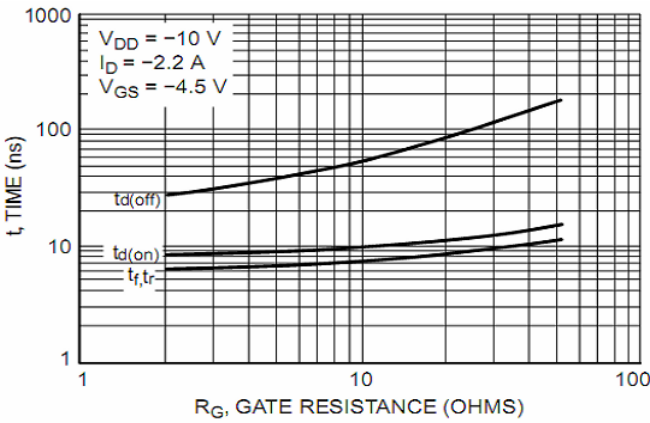
**Typical Performance Graph (P-Channel)**

**On-Region Characteristics**

**Transfer Characteristics**

**On-Resistance versus Drain Current**

**On-Resistance versus Drain Current and Gate Voltage**

**On-Resistance Variation with Temperature**

**Drain-to-Source Leakage Current versus Voltage**



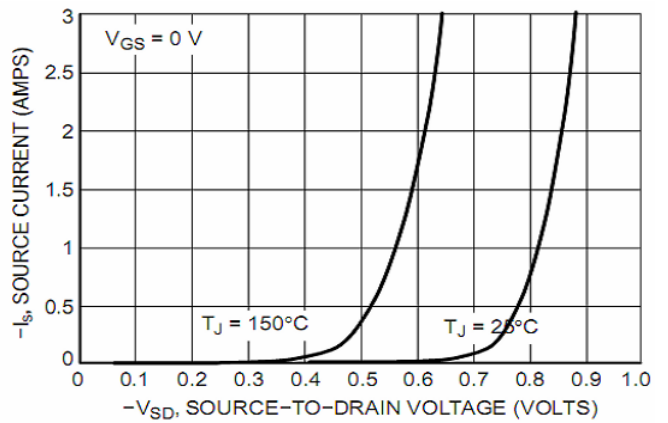
Capacitance Variation



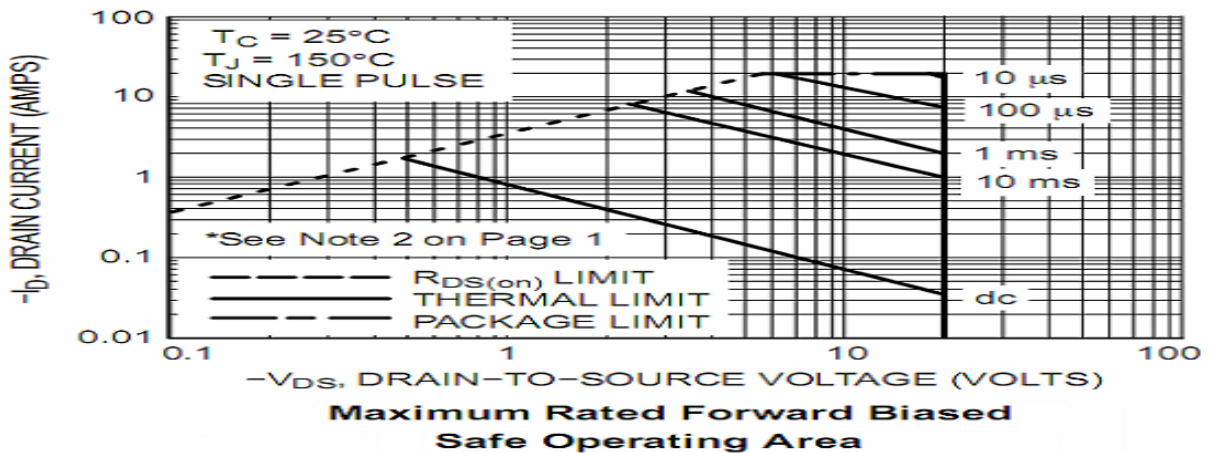
Gate-To-Source and Drain-To-Source Voltage versus Total Charge



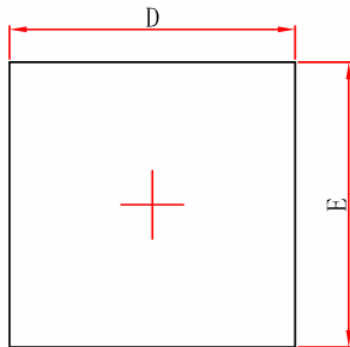
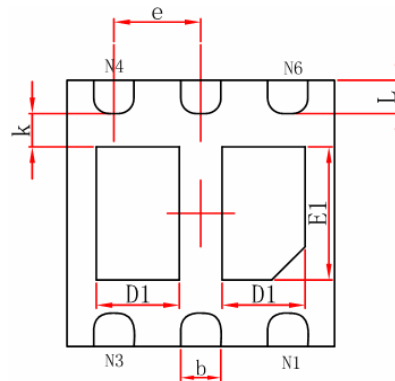
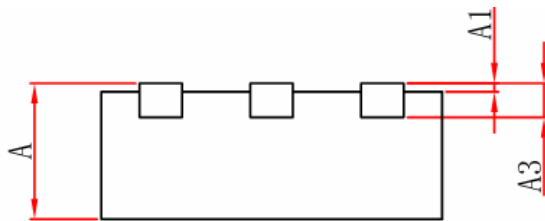
Resistive Switching Time Variation versus Gate Resistance



Diode Forward Voltage versus Current





**Package Outline Dimension**
**DFN2x2-6L Dual**

**Top View**

**Bottom View**

**Side View**

Symbol	Dimension in Millimeters	
	Min.	Max.
A	0.700	0.800
A1	0.000	0.050
A3	0.203REF	
D	1.924	2.076
E	1.924	2.076
D1	0.520	0.720
E1	0.900	1.100
k	0.200MIN	
b	0.250	0.350
e	0.650TYP	
L	0.174	0.326